

New Assembly Site for DiskOnChip TSOP Products



Description

The DiskOnChip products listed below, which are manufactured by Toshiba, will be assembled in the new Toshiba facility in Taiwan starting at the end of July. As a result of this change, the product markings and the package dimensions will be affected.

Ordering Information

The following DiskOnChip products will be affected:

Product Description	Package	Capacity	Ordering Information
DiskOnChip Millennium Plus Commercial/Extended Temperature	TSOP-I	128Mbit (16MByte)	MD2811-D16-V3Q18-T
	TSOP-I	256Mbit (32MByte)	MD2811-D32-V3-T

Reason for Change

Due to internal reorganization on the part of the FAB manufacturer, the assembly facility has been transferred from Japan to Taiwan.

Availability

The assembly in the new facility will commence in July 2002.

Compatibility

The products assembled in the new facility are fully hardware and software compatible with the existing products. Only the product markings and package dimensions are affected, as detailed below.

Tape & Reel Packaging

The tape & reel packaging will be different for products shipped from the new facility, as shown below:

Material	Item	Current	New
Carrier Tape	Design	Toshiba Original Carrier Tape	PTI Standard Carrier Tape
Carton Box	Dimensions	350 x 360 x 57 mm	280 x 267 x 60 mm
	Spacer	L-type spacer	None
Shipping Box	Dimensions	375 x 385 x 300 mm	300 x 280 x 340 mm

Device Marking

Products assembled in Taiwan will have a different marking, as shown below:

Existing Marking
DiskOnChip Millennium Plus 128Mbit



New Marking
DiskOnChip Millennium Plus 128Mbit



Where:

yyww: year and week

zzz: FAB marking

\$\$\$\$\$\$: Toshiba internal marking

Existing Marking
DiskOnChip Millennium Plus 256Mbit



New Marking
DiskOnChip Millennium Plus 256Mbit



Where:

yyww: year and week

zzz: FAB marking

\$\$\$\$\$\$: Toshiba internal marking

How to Contact Us

Please contact your M-Systems representative or visit the DiskOnChip web page on the M-Systems website (www.m-sys.com) for any further information or assistance.

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